

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# **TF412S**

# **N-Channel JFET** 30V, 1.2 to 3.0mA, 5.0mS, SOT-883



http://onsemi.com

#### **Features**

- Small IGSS:  $max -1.0nA (V_{GS} = -20V, V_{DS} = 0V)$
- Small Ciss: typ 4pF (VDS=10V, VGS=0V, f=1MHz)
- Ultrasmall package facilitates miniaturization in end products
- Halogen free compliance

### **Applications**

• Low-Frequency general-purpose amplifier, impedance conversion, infrared sensor applications

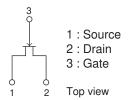
## **Specifications**

## Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V <sub>DSX</sub>	30	V
Gate-to-Drain Voltage	V <sub>GDS</sub>	-30	V
Gate Current	IG	10	mA
Drain Current	ΙD	10	mA
Power Dissipation	PD	100	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

This product is designed to "ESD immunity < 200V\*", so please take care when handling.

#### **Electrical Connection**



### **Marking**







#### **Ordering & Package Information**

Device	Package	Shipping
TF412ST5G		0.000
Pb-free and	SOT-883	8,000
Halogen Free		pcs. / reel

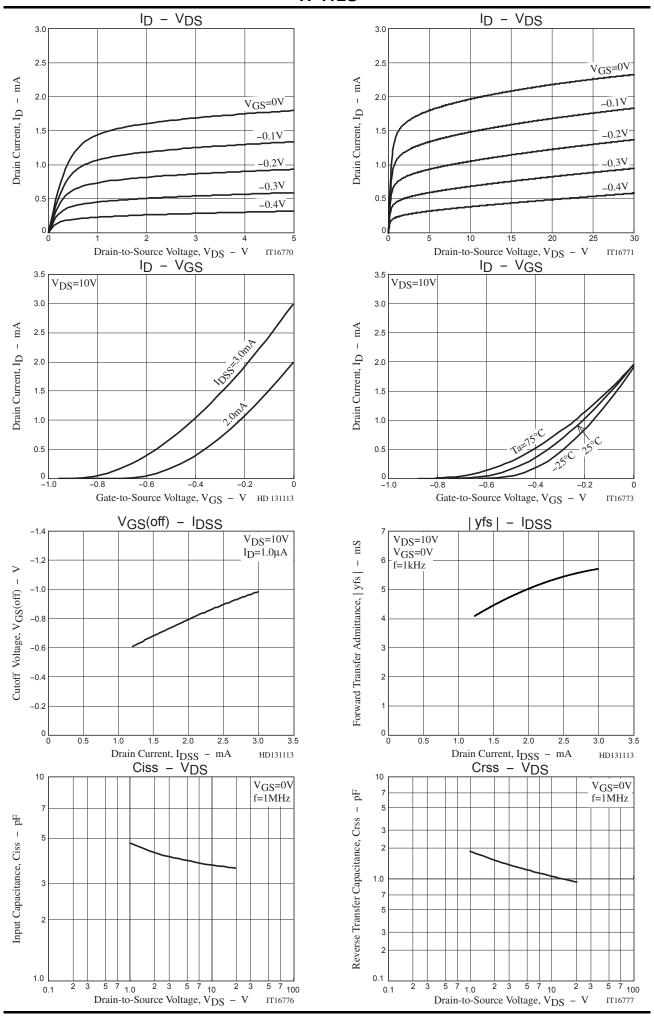
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

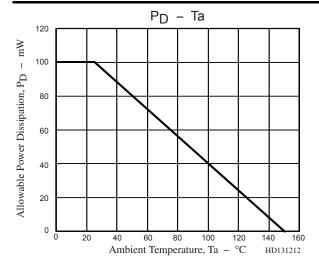
#### **Electrical Characteristics** at Ta = 25°C

Parameter	Cumbal	Conditions	Value			1.1
	Symbol Conditions	Conditions	min	typ	max	Unit
Gate-to-Drain Breakdown Voltage	V <sub>(BR)</sub> GDS	$I_{G} = -10\mu A, V_{DS} = 0V$	-30			V
Gate-to-Source Leakage Current	IGSS	$V_{GS} = -20V, V_{DS} = 0V$			-1.0	nA
Cutoff Voltage	V <sub>GS</sub> (off)	$V_{DS} = 10V, I_D = 1\mu A$	-0.18	-0.80	-1.5	V
Drain Current	IDSS	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V	1.2		3.0	mA
Forward Transfer Admittance	yfs	V <sub>DS</sub> = 10V, V <sub>GS</sub> =0V, f = 1kHz	3.0	5.0		mS
Input Capacitance	Ciss	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz		4		pF
Reverse Transfer Capacitance	Crss	VDS 10V, VGS 0V, 1 111112		1.1		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>\*</sup> Machine Model



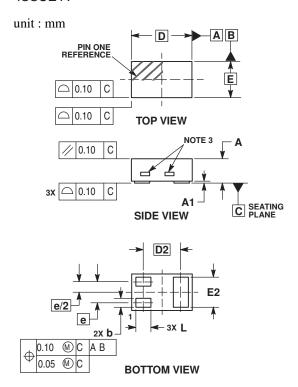


# **Package Dimensions**

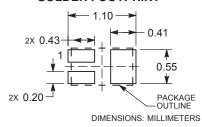
TF412ST5G

### SOT-883 (XDFN3), 1.0x0.6, 0.35P CASE 506CB

**ISSUE A** 



#### RECOMMENDED **SOLDER FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS
- 3. EXPOSED COPPER ALLOWED AS SHOWN

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.340	0.440	
A1	0.000	0.030	
b	0.075	0.200	
D	0.950	1.075	
D2	0.620 BSC		
е	0.350 BSC		
Е	0.550	0.675	
E2	0.425	0.550	
	0.170	0.300	

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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